DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

		Attorney Docket	: No	
As a below named i	nventor, I hereby d	eclare that:		
My residence, post	office address and o	citizenship are as stated belo	ow next to my name.	
I believe I am the or original, first and joi	iginal, first and sole nt inventor (if plura	e inventor (if only one name al names are listed below) of	is listed below) or an f the subject matter which is "COMPOSITION FOR FORMING AME, INTERLEVEL INSULATOR	
the specification of v [X] is attached hereto	vhich o			
[] was filed on International Applica	tion Number	as United States Applica and was amended o	ation No or PCT on (if applicable).	
I nereby state that I h	ave reviewed and	anderstand the contents of the lended by any amendment re		
I acknowledge the du Title 37 Code of Fede	ty to disclose infor	motion 1:1:	patentability as defined in	
I hereby claim foreign priority benefits under Title 35, United States Code, §119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate, or §365(a) of any PCT america, listed below and have also identified below any foreign application for patent or inventor's certificate, or of any PCT International application having a filing date before that of the application on which priority is claimed.				
2003-087066	JAPAN	March 27, 2003	[X] Yes [] No	
Number	Country	MM/DD/YYYY Filed	Priority Claimed	
			[] Yes [] No	

MM/DD/YYYY Filed

MM/DD/YYYY Filed

Priority Claimed

[] Yes [] No

Priority Claimed

Number

Number

Country

Country

I hereby claim the benefit under Title 35, United States Code, §119(e) of any United States provisional application(s) listed below.

Application Number	Filing Date (MM/DD/YYYY)
Application Number	Filing Date (MM/DD/YYYY)

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) or §365(c) of any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application (37 C.F.R. §1.63(d)).

Application No.	Filing Date	Status Patented/Pending/Abandoned
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the practitioners associated with the Customer Number provided below to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and direct that all correspondence be addressed to that Customer Number:

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